

BGO827; BGO827/FC0; BGO827/SC0

870 MHz optical receivers

Rev. 5 — 29 September 2010

Product data sheet

1. Product profile

1.1 General description

High dynamic range optical receiver amplifier modules in a standard SOT115 package where the non-jacketed fiber has either no connector or has an FC/APC or SC/APC connector.

The amplifier supply voltage pin and the photodiode bias voltage pin both connect to 24 V (DC).

The modules have a mono mode optical input suitable for 1290 nm to 1600 nm wavelengths, a terminal to monitor the photodiode current and an electrical output having a characteristic impedance of 75 Ω .

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

1.2 Features and benefits

- Excellent linearity
- Low noise
- Excellent flatness
- Standard CATV outline
- Rugged construction
- Gold metallization ensures excellent reliability
- High optical input power range

1.3 Applications

CATV optical node systems operating in the 40 MHz to 870 MHz frequency range.



1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
f	frequency range		40	-	870	MHz
S ₂₂	output return losses	f = 40 MHz to 870 MHz	11	-	-	dB
	optical input return losses		45	-	-	dB
d_2	second order distortion	f = 854.5 MHz	-	-	-57	dB
F	equivalent noise input	f = 40 MHz to 870 MHz	-	-	8.5	pA/√Hz
I _{tot}	total current consumption (DC)	V _B = 24 V	175	-	205	mA

2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	Graphic symbol
BGO827	(SOT115T)		
1	monitor current		
2, 3	common	1 5 7 9	4 5
4	+V _B of the photodiode		9
5	+V _B of the amplifier		⊕
7, 8	common		1 2, 3, 7, 8
9	output		sym098
BGO827/	FC0 (SOT115X)		
1	monitor current		
2, 3	common	1 5 7 9	4 5
4	+V _B of the photodiode		9
5	+V _B of the amplifier		⊕
7, 8	common		1 2, 3, 7, 8
9	output		sym098
BGO827/	SC0 (SOT115Y)		
1	monitor current		
2, 3	common	1 5 7 9	4 5
4	+V _B of the photodiode		9
5	+V _B of the amplifier		
7, 8	common		1 2, 3, 7, 8
9	output		sym098

3. Ordering information

Table 3. Ordering information

Type number	Package						
	Name	Description	Version				
BGO827	-	rectangular single-ended package; aluminium flange; 2 vertical mounting holes; $2 \times 6-32$ UNC and 2 extra horizontal mounting holes; optical input; 8 gold-plated in-line leads	SOT115T				
BGO827/FC0	-	rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2×6 -32 UNC and 2 extra horizontal mounting holes; optical input with connector; 8 gold-plated in-line leads	SOT115X				
BGO827/SC0	-	rectangular single-ended package; aluminium flange; 2 vertical mounting holes; $2 \times 6-32$ UNC and 2 extra horizontal mounting holes; optical input with connector; 8 gold-plated in-line leads	SOT115Y				

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
f	frequency range		40	870	MHz
T _{stg}	storage temperature		-40	+85	°C
T _{mb}	mounting base temperature		-20	+85	°C
P _{in}	optical input power	continuous	-	5	mW
ESD	ESD sensitivity	human body model; R = 1.5 kΩ; C = 100 pF	500	-	V

5. Characteristics

Table 5. Characteristics

Bandwidth 40 MHz to 870 MHz; $V_B = 24 \text{ V}$; $T_{mb} = 30 \text{ °C}$; $Z_L = 75 \Omega$.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
S	responsivity					
	BGO827	$\lambda = 1300 \text{ nm}$	800	-	-	V/W
	BGO827/FC0; BGO827/SC0		750	-	-	V/W
ΔS	responsivity difference	responsivity at T_{mb} = 85 °C – responsivity at T_{mb} = 30 °C; f = 870 MHz	-	-50	-	V/W
FL	flatness straight line (peak to valley)	f = 40 MHz to 870 MHz	-	-	1	dB
SL	slope straight line	f = 40 MHz to 870 MHz	0	-	2	dB
ΔSL	slope difference	slope at T_{mb} = 85 °C – slope at T_{mb} = 30 °C	-	-0.35	-	dB
s ₂₂	output return losses	f = 40 MHz to 870 MHz	11	-	-	dB
	optical input return losses		45	-	-	dB

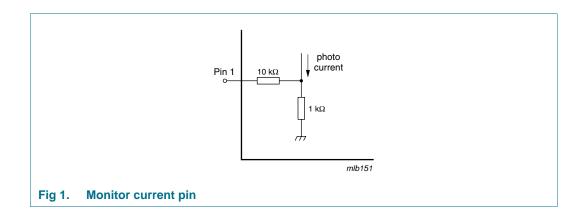
 Table 5.
 Characteristics ...continued

Bandwidth 40 MHz to 870 MHz; $V_B = 24$ V; $T_{mb} = 30$ °C; $Z_L = 75$ Ω .

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
d ₂	second order distortion	$f_{m} = 446.5 \text{ MHz}$	[1][2]	-	-	-68	dB
		f _m = 746.5 MHz	[1][3]	-	-	-63	dB
		f _m = 854.5 MHz	[1][4]	-	-	-57	dB
∆d2	second order distortion difference	d_2 at T_{mb} = 85 °C - d_2 at T_{mb} = 30 °C		-	2.5	-	dB
		d_2 at $T_{mb} = -20 \text{ °C} - d_2$ at $T_{mb} = 30 \text{ °C}$		-	-1.5	-	dB
d ₃	third order distortion	f _m = 853.25 MHz	[5][6]	-	-	-73	dB
∆d3	third order distortion difference	d_3 at T_{mb} = 85 °C - d_3 at T_{mb} = 30 °C		-	1	-	dB
		d_3 at $T_{mb} = -20 ^{\circ}\text{C} - d_3$ at $T_{mb} = 30 ^{\circ}\text{C}$		-	–1	-	dB
F	equivalent noise input	f = 40 MHz to 450 MHz		-	-	7	pA/√Hz
		f = 450 MHz to 750 MHz		-	-	8	pA/√Hz
		f = 750 MHz to 870 MHz		-	-	8.5	pA/√Hz
s_{λ}	spectral sensitivity	λ = 1310 ±20 nm		0.85	-	-	A/W
		λ = 1550 ±20 nm		0.9	-	-	A/W
λ	optical wavelength			1290	-	1600	nm
L	length of optical fiber	SM type; 9/125 μm					
	BGO827			1	-	-	m
	BGO827/FC0; BGO827/SC0			746	-	861	mm
I _{tot}	total current consumption (DC)			175	-	205	mA
I _{bias}	diode bias current at pin 4 (DC)			-	-	25	mA

^[1] Two laser test; each laser with a modulation index of 40 %; $P_{opt} = 1$ mW (total)

^[6] $f_m = 853.25 \text{ MHz}$; $f_p = 133.25 \text{ MHz}$; $f_q = 265.25 \text{ MHz}$; $f_r = 721.25 \text{ MHz}$



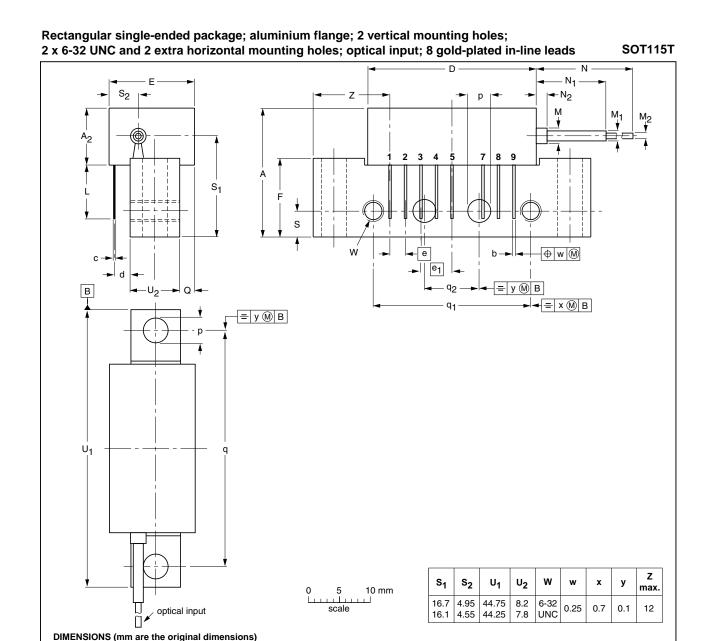
^[2] $f_m = 446.5 \text{ MHz}$; $f_p = 97.25 \text{ MHz}$; $f_q = 349.25 \text{ MHz}$

^[3] $f_m = 746.5 \text{ MHz}$; $f_p = 133.25 \text{ MHz}$; $f_q = 613.25 \text{ MHz}$

^[4] $f_m = 854.5 \text{ MHz}$; $f_p = 133.25 \text{ MHz}$; $f_q = 721.25 \text{ MHz}$

^[5] Three laser test; each laser with a modulation index of 60 %; Popt = 1 mW (total)

6. Package outline



OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT115T					-04-02-04- 10-06-18

 $M \mid M_1 \mid M_2$

F

min.

e₁

5.08 | 12.7 | 8.8 | 2.5

Ν

min

0.9 1000

1.6

N₁ N₂

10.7 5

Q

max

q q₁

38.1 25.4 10.2 4.2

р

4.15

Fig 2. Package outline SOT115T

A₂

0.51

0.25 27.2

max

20.8 9.5

D d E

max. max. max

2.54 | 13.75 | 2.54

BGO827_FC0_SC0

q₂ S

Rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes; optical input with connector; 8 gold-plated in-line leads

SOT115X

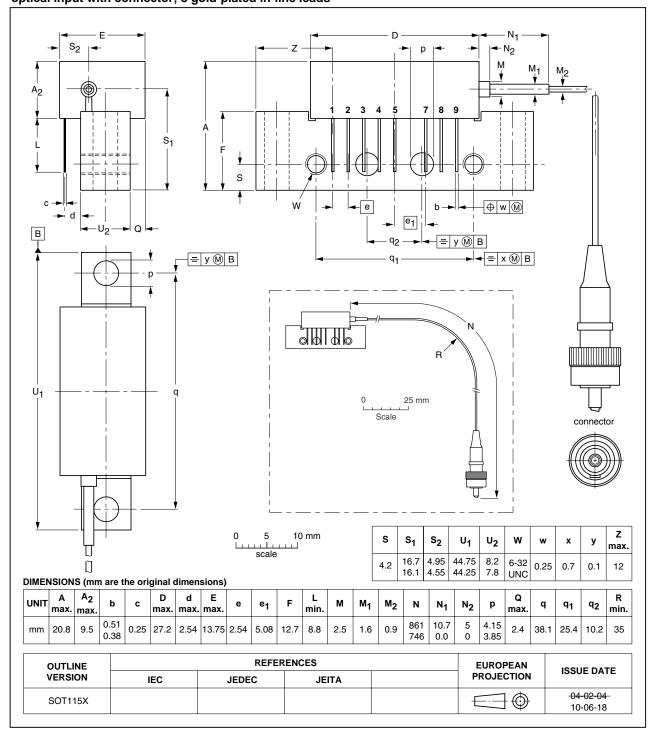


Fig 3. Package outline SOT115X

Rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes; optical input with connector; 8 gold-plated in-line leads

SOT115Y

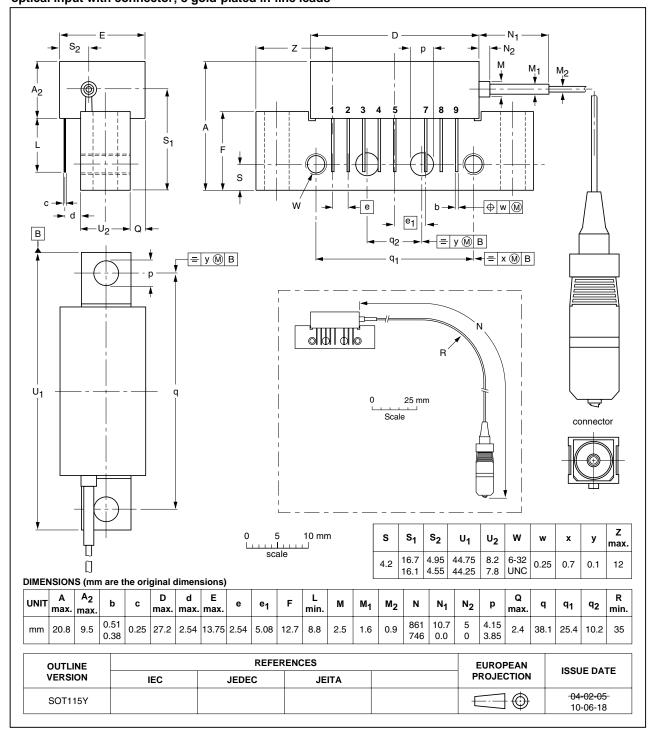


Fig 4. Package outline SOT115Y

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7. Handling information

Fiberglass optical coupling: maximum tensile strength = 5 N; minimum bending radius = 35 mm.

8. Revision history

Table 6. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BGO827_FC0_SC0 v.5	20100929	Product data sheet	-	BGO827_FC0_SC0 v.4
Modifications:		of this data sheet has been r of NXP Semiconductors.	edesigned to comply	with the new identity
	 Legal texts 	have been adapted to the ne	w company name wh	ere appropriate.
	 Package ou 	tline and simplified outline di	awings have been up	odated to the latest version.
BGO827_FC0_SC0 v.4 (9397 750 14436)	20050329	Product data sheet	-	BGO827_FC0_SC0 v.3
BGO827_FC0_SC0 v.3 (9397 750 13061)	20040407	Product specification	-	BGO827_FC0_SC0 v.2
BGO827_FC0_SC0 v.2 (9397 750 10522)	20021210	Product specification	-	BGO827_FC0_SC0 v.1
BGO827_FC0_SC0 v.1 (9397 750 09934)	20020627	Product specification	-	-

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9. Legal information

9.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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